

Integration of Electrocatalysts with Silicon Microcone Arrays for Minimization of Optical and Overpotential Losses during Sunlight-Driven Hydrogen Evolution

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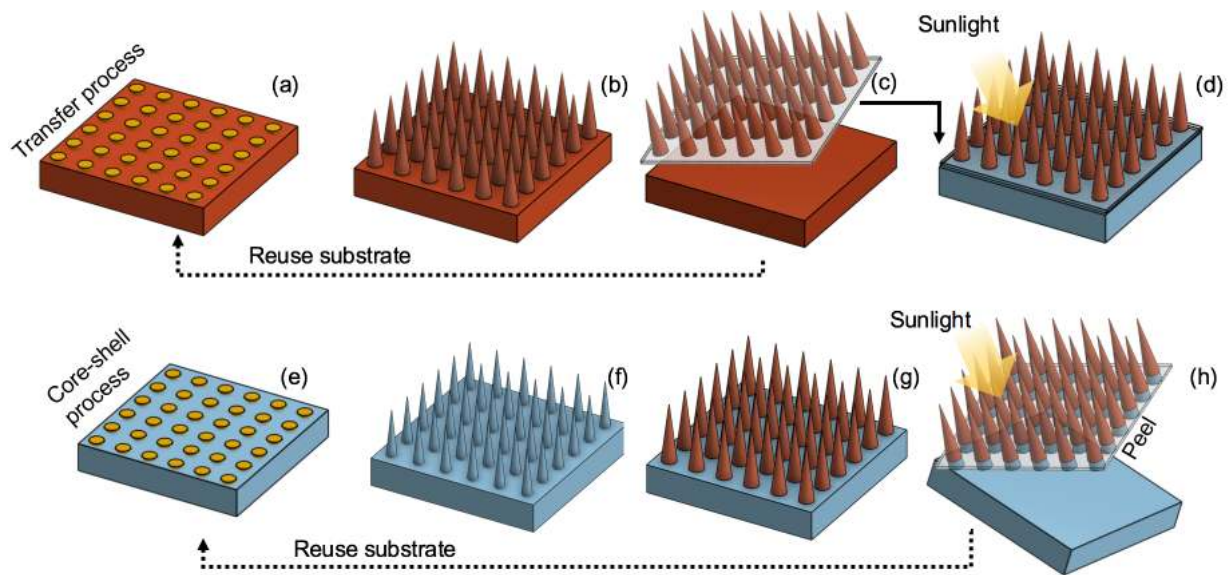


Figure S1: Process flow diagrams for two methods of fabricating integrated solar fuels devices. Scalable integration of a wide band gap top cell with a monolithic Si bottom cell could be achieved via: (a) patterning a crystalline III-V semiconductor substrate with Au seeds or Cr masks for vapor-liquid-solid growth or dry etching, respectively; (b) fabricating a micro- or nanocone array via vapor-liquid-solid growth followed by chemical etching or dry etching.^{1,2} (c) embedding the micro- or nanocone array in a flexible polymer, and removing it from the substrate for transfer;¹ (d) metallizing the array with catalysts and ohmic contacts on the top- and bottom-facing sides, respectively, for integration with a Si bottom cell. Fabrication of a tandem, core-shell microcone array embedded in an ion conducting membrane could be achieved via: (e) patterning a Si substrate with Cu seeds or Al₂O₃ masks; (f) fabricating a microcone array as in (b), and coating with an ohmic contact such as indium-tin-oxide; (g) depositing a wide band gap semiconductor via metal-organic chemical vapor deposition,³ thermochemical conversion from solution,⁴ or electrochemical growth,⁵ on the surface of the microcone array, leading to a core-shell architecture; (d) infilling the arrays with an ion exchange membrane and peeling from the substrate. The substrate can be re-patterned to reduce material demands.

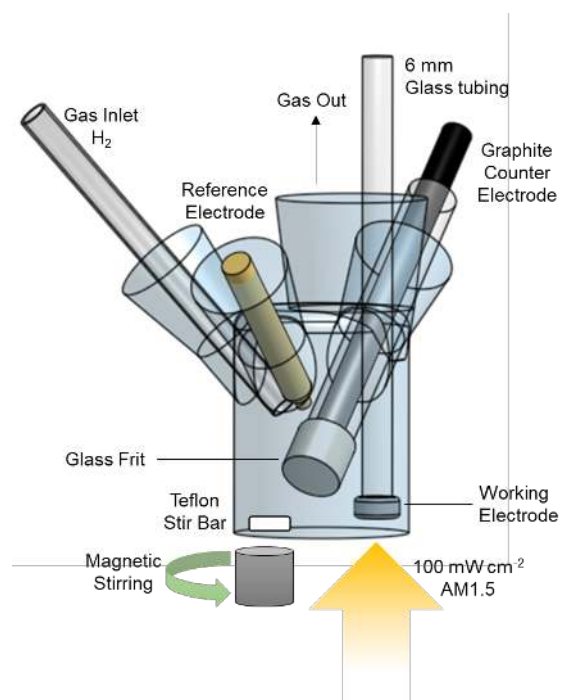


Figure S2: Schematic diagram of the cell used for photoelectrochemical hydrogen evolution testing of devices. Illumination was directed into the base of the cell onto a bottom facing photoelectrode.

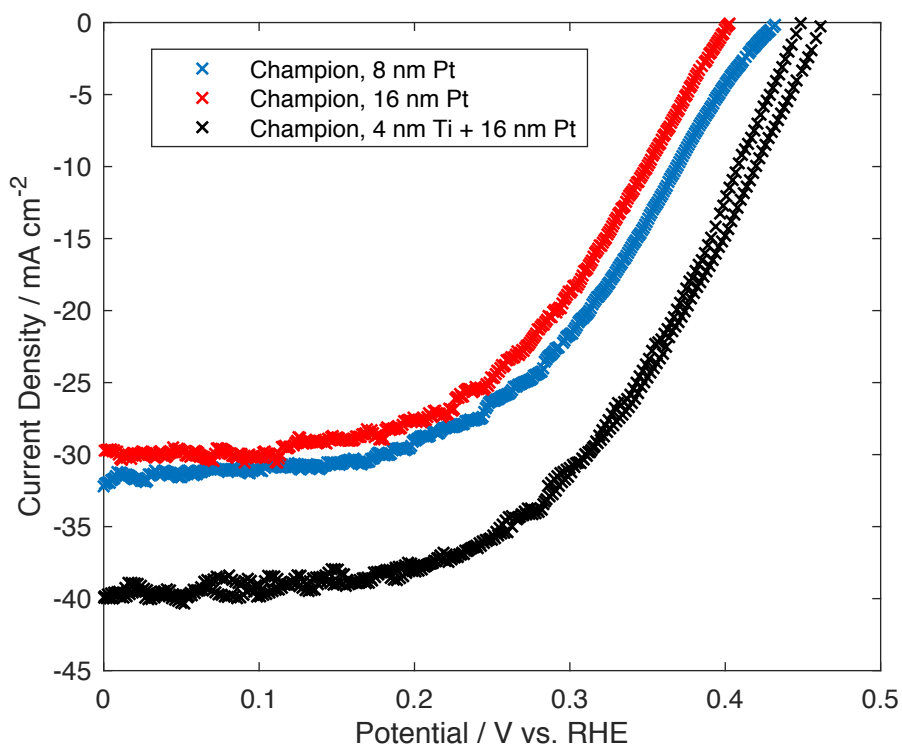


Figure S3: Initial performance (scan 1) of the best-performing n^+p -Si/Pt μ -cone photocathodes with 8 nm or 16 nm thick Pt loaded on the tips of the μ -cones. The photocathodes were tested in H_2 -saturated 0.50 M $H_2SO_4(aq)$ under 100 mW cm^{-2} of simulated AM1.5 illumination, with rapid stirring of the electrolyte to remove bubbles from the electrode surface.

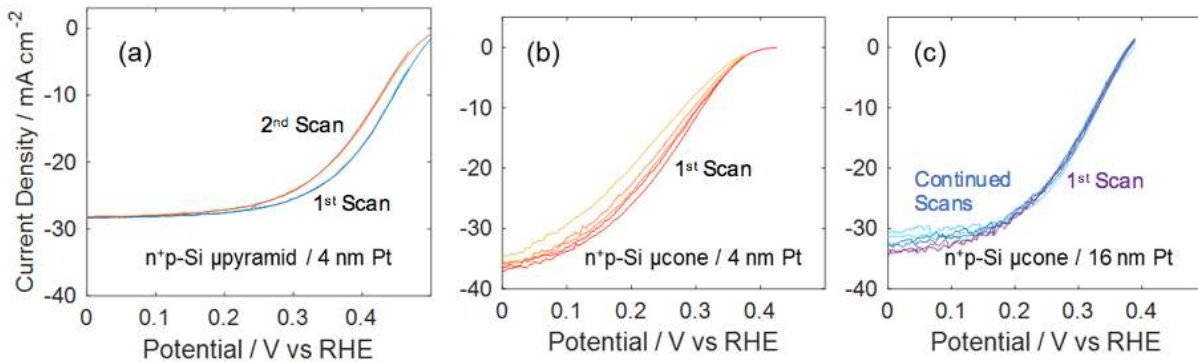


Figure S4: Stability of n⁺p-Si/Pt photocathodes operated in contact with H₂-saturated 0.5 M H₂SO₄(aq) while under 100 mW cm⁻² of simulated AM1.5 illumination. For n⁺p-Si/Pt μ-pyramid photocathodes with (a) 4 nm of Pt, a decrease in fill factor (red trace) was observed after the first potential scan (blue trace). For n⁺p-Si/Pt μ-cones, devices with (b) 4 nm of Pt on the μ-cone tips showed a decrease in fill factor with successive scans (yellow traces), whereas devices with (c) 16 nm of Pt did not show an improvement in J_{ph} and no decay in fill factor (blue traces) after the first scan (purple trace).

Extended Methods

Stability testing: Extended stability testing of n⁺p-Si/Ti/Pt and p-Si/Co-P μ -cone arrays was performed under nominally identical conditions as those used for photoelectrochemical testing, but with a Pt mesh electrode counter electrode behind a Nafion membrane (Fuel Cell Store). H₂ was bubbled through the electrolyte for the duration of the stability tests to maintain a dissolved concentration of H₂ in equilibrium with 1 atmosphere of H₂(g).

Electrochemical impedance spectroscopy: Electrochemical impedance spectra were measured under nominally identical conditions to those used in photoelectrochemical testing. A sinusoidal perturbation of amplitude 25 mV was applied to the potential of the working electrode and the impedance response was recorded over a frequency range from 7 MHz to 20 Hz.

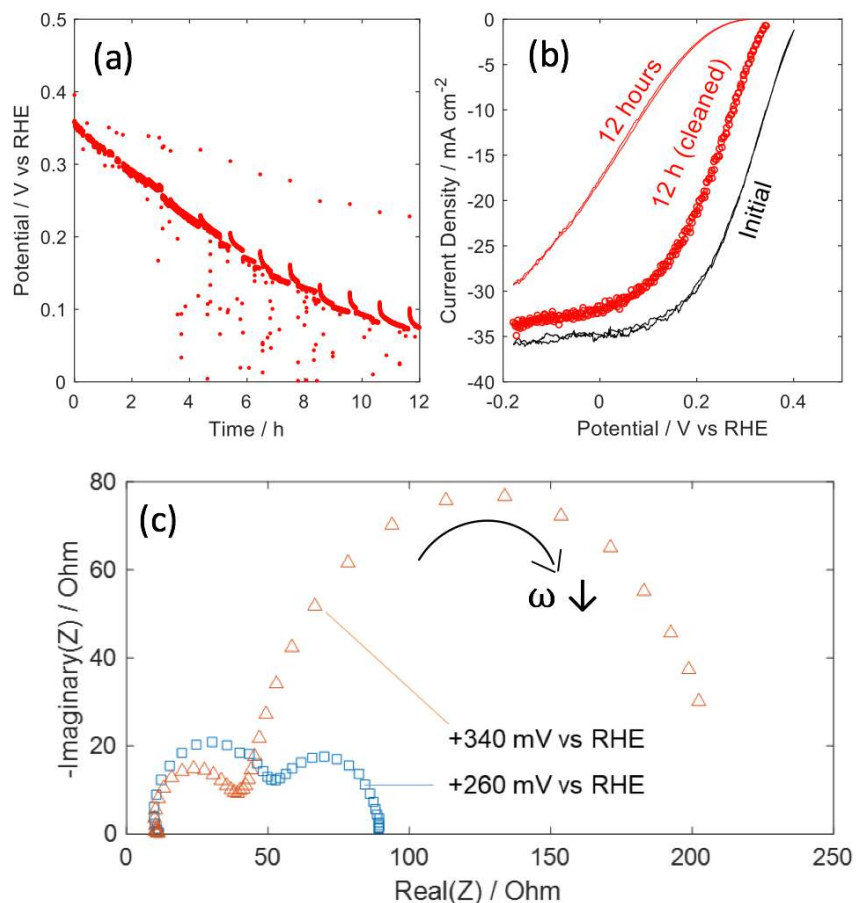


Figure S5: Stability testing of n^+p -Si/Pt μ -cone array photocathodes in H_2 purged 0.50 M $H_2SO_4(aq)$ under 1-Sun illumination. (a) Chronopotentiometry at -10 mA cm^{-2} for 12 h. Cyclic voltammograms were periodically recorded at 50 mV s^{-1} to monitor the J - E behavior of the device. (b) J - E behavior of a representative photocathode before testing (black line), after 12 h of chronopotentiometry at -10 mA cm^{-2} (red line), and after 10 s in aqua regia and rinsing with copious deionized water (red circles). (c) Nyquist plot for an n^+p -Si/Pt μ -cone array photocathode after testing, recorded under 1-Sun illumination, in 0.5 M $H_2SO_4(aq)$, over a frequency range of 2 MHz to 20 Hz, at +260 mV (orange) and +340 mV (blue) vs RHE.

Stability testing: Results and Discussion

A comparison of the J - E behavior of the device before and after 12 h of chronopotentiometry (Figure S5a) revealed that the fill factor degraded during extended operation at negative potentials relative to open-circuit (Figure S5b). Cleaning the device via a 10 s dip in 3:1 (vol) hydrochloric acid and nitric acid, and rinsing with copious deionized H₂O, restored a substantial fraction of the initial fill factor. The presence of a 4 nm Ti adhesion layer in n⁺p-Si/Ti/Pt μ -cone array photocathodes did not affect the stability of the catalyst layer. Furthermore, comparisons of SEMs of devices before and after 12 h of continuous testing in 0.50 M H₂SO₄(aq) did not reveal changes to the morphology or coverage of the Ti/Pt layer during extended operation (Figure S6). Thus, the loss in V_{-10} can be attributed to reduced activity of the thin metal film and not to delamination or loss of catalyst material.

The frequency-dependent impedance response for n⁺p-Si/Pt μ -cone array photocathodes is plotted in Figure S5c. Two distinct semicircles were observed when plotting the negative of the imaginary component of the impedance against the real component of the impedance, a Nyquist Plot. Semicircles that can be separated by frequency indicate the presence of multiple charge trapping regions which exhibit time constants differing by at least an order of magnitude.⁶ Such a response has been reported previously at silicon and hematite photoelectrodes decorated with catalysts.^{6,7} Multiple equivalent circuits can be fit to this response. An unambiguous assignment of the individual capacitances and resistances could be achieved by a systematic variation of doping concentration and catalyst coverages at the devices; this is beyond the focus of the present study. In the high-frequency limit, the impedance contribution from capacitance is minimized such that the total impedance is dominated by the ohmic resistance of the cell, which was ~10 ohms. In the low-frequency limit, the impedance of all capacitances is large, and the real component of the impedance approaches the direct current polarization resistance of the cell. At all potentials, the polarization resistance was larger than the series resistance.

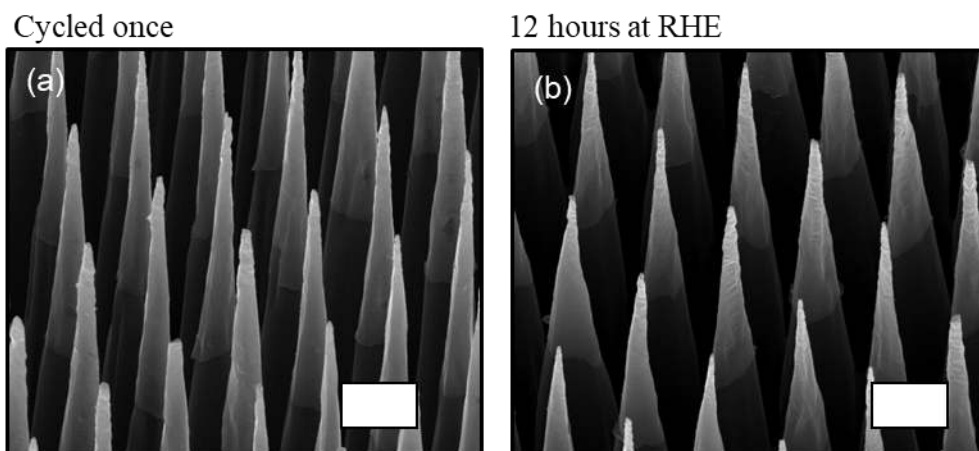


Figure S6: SEM images at 10 kV and 30 degree sample tilt of n^+p -Si/Ti/Pt μ -cone array photocathodes (a) before and (b) after 12 h of chronoamperometric testing in 0.50 M $H_2SO_4(aq)$ under simulated AM1.5 illumination at RHE. Scale bars represent 5 μm at 0 degrees tilt.

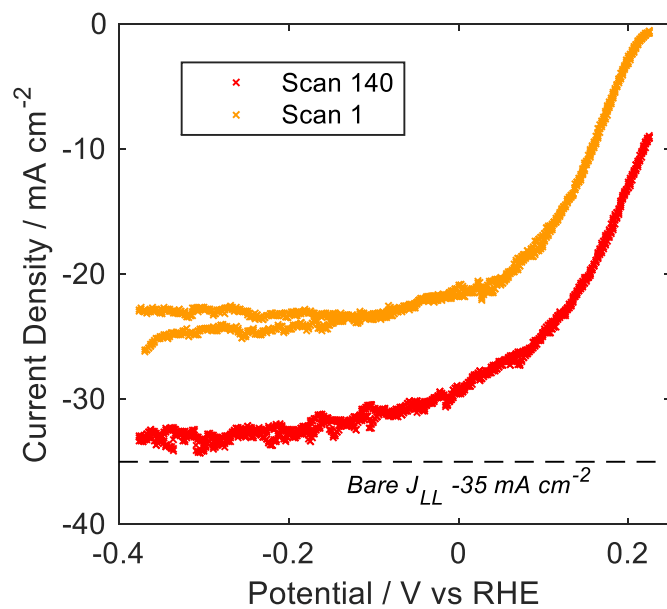


Figure S7: J - E behavior of the best-performing p-Si/CoP μ -cone photocathodes with 400 mC cm⁻² Co-P deposited photoelectrochemically. The device was cycled from the initial open-circuit potential to -0.376 V vs RHE in H₂-saturated 0.50 M H₂SO₄(aq) under 100 mW cm⁻² of simulated AM1.5 illumination, with rapid stirring of the electrolyte to remove bubbles from the electrode surface.

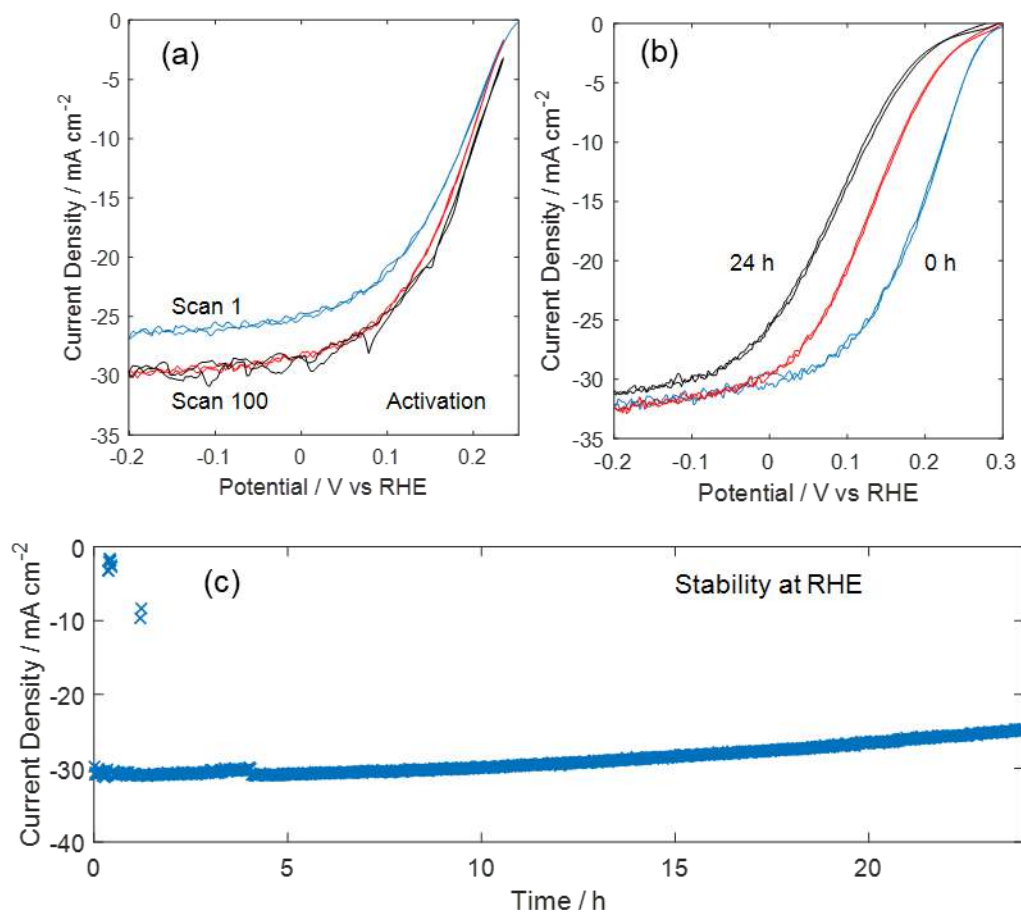
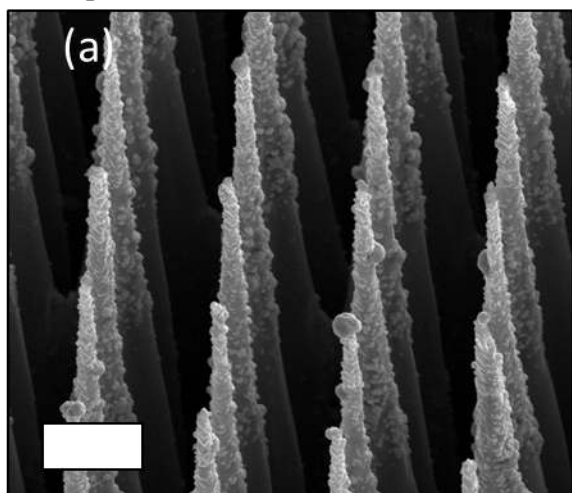


Figure S8: Extended photoelectrochemical testing of a p-Si/CoP μ -cone photocathode with 400 mC cm⁻² Co-P. (a) Current density vs potential behavior in H₂-saturated 0.50 M H₂SO₄(aq) under 100 mW cm⁻² of simulated AM1.5 illumination, with rapid stirring of the electrolyte for the 1st, 10th, and 100th cycle at 50 mV s⁻¹, blue, red, and black circles, respectively. The 100th scan occurred after 30 min of cycling. (b) Comparison of the $J-E$ behavior over 24 h of continuous H₂(g) evolution at RHE under 1-Sun illumination for the device activated in (a). The initial, 12 h, and 24 h $J-E$ behavior is shown in blue, red, and black respectively. (c) Chronoamperometry trace for the device activated in (a).

As Deposited



24 hours in 0.5M H₂SO₄

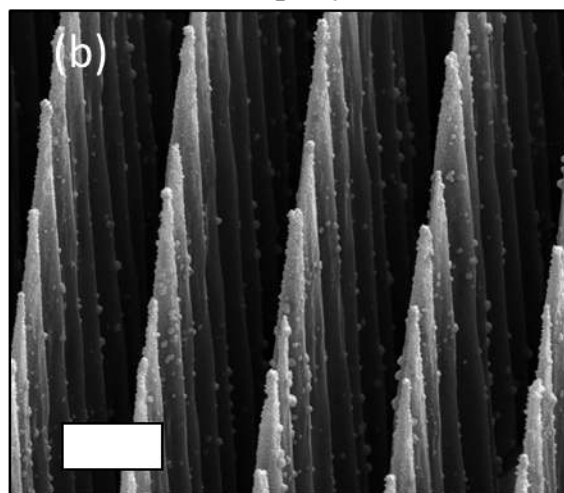


Figure S9: Scanning-electron micrographs of the p-Si/CoP μ -cone photocathode with 400 mC cm^{-2} Co-P before (A) and after (B) testing in 0.50 M H₂SO₄(aq) under 1-Sun illumination for 24 h. Scale bars represent 5 μm at 0 degrees tilt.

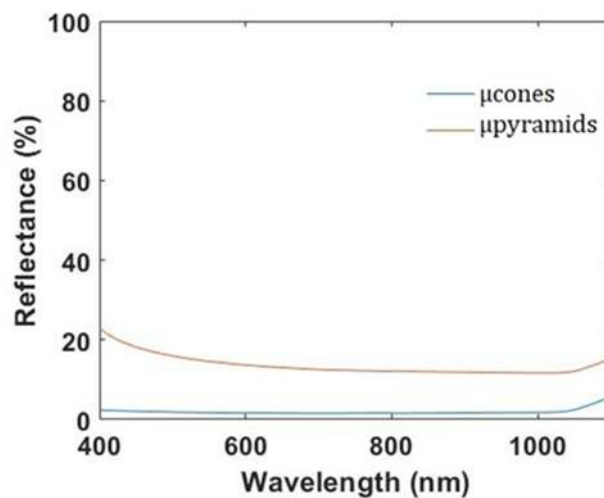


Figure S10: Comparison of reflection from bare Si μ -pyramids and bare Si μ -cones as measured using a Cary 5000 UV-VIS spectrometer with an integrating sphere.

Supporting References

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